

## THERMAL ANALYSIS IN THIN-FILM FLUID REGIONS OF RECTANGULAR MICROGROOVE

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*The effects of contact angle and superheat on thin film thickness and heat flux distribution occurring in a rectangle microgroove are numerically simulated. Accordingly, physical and mathematical models are built in detail. Numerical results indicate that meniscus radius and thin film thickness increase with the improvement of contact angle. The heat flux distribution in the thin film region increases nonlinearly as the contact angle decreases. The total heat transfer through the thin film region increases with the improvement of superheat, and decreases as the contact angle increases. When the contact angle is equal to zero, the heat transfer in the thin film region accounts for more than 80% of the total heat transfer. Intensive evaporation in the thin film region plays a key role in heat transfer for the rectangle capillary microgroove. The liquid with higher wetting performance is more capable of playing the advantages of higher intensity heat transfer in thin film region. The current investigation will result in a better understanding of thin film evaporation and its effect on the effective thermal conductivity in the rectangle microgroove.*

Key words: *Contact angle; Film thickness; Heat flux distribution; Rectangle microgroove*

### 1. Introduction

Rapid advances in the electronics industry have led to a great interest in high heat flux dissipation devices. Thin-film evaporation plays an important role in these modern highly efficient heat transfer devices [1, 2]. When thin-film evaporation occurs in the thin-film region, most of the heat transfers through a narrow area between the non-evaporation region and intrinsic meniscus region. The flow resistance of the vapor phase during thin-film evaporation is very small compared with the vapor flow in the liquid phase in a typical nucleate boiling heat transfer configuration. In addition, the superheat needed for the phase change in the thin-film region is much smaller than that for a bubble growth in a typical nucleate boiling, in particular, at the initial stage of the bubble growth. The heat transfer efficiency of thin-film evaporation is much higher than the nucleate boiling heat transfer. It is known that the thermodynamic properties of the liquid thin-film region are very different from those of the macroregion.

The thin-film evaporating region has been studied extensively by many investigators. Jiao et al. [3] developed a theoretical model predicting the heat transfer

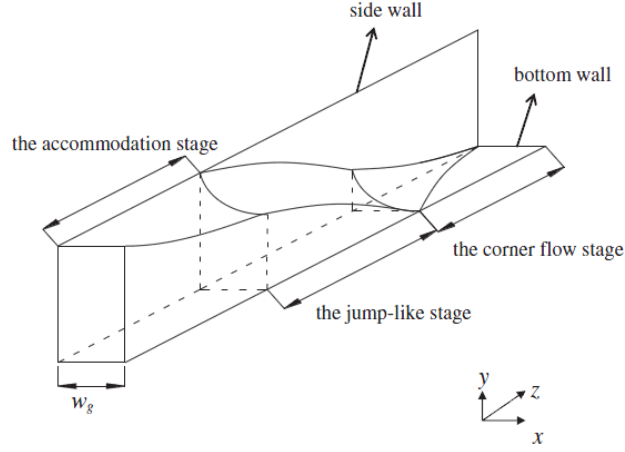
performance occurring in a grooved heat pipe. Li et al. [4] investigated the critical heat flux and evaporation rates from capillary wicking structures. It was found that the critical heat flux depended heavily on the thickness of the capillary wick while the overall evaporation heat transfer was independent of wick thickness. Jiao et al. [5] also proposed an analytical model that could predict the effects of contact angle on the thin-film profile and meniscus radius within a micro trapezoidal groove. It was found that the thin-film evaporation governed the maximum heat transfer capability in a grooved heat pipe. Do et al. [6] developed a mathematical model which accurately predicted the thermal performance of a flat micro heat pipe with rectangular grooves. Ranjan et al. [7] developed a numerical model based on a static, evaporating film meniscus in various wick structures in heat pipes. A parametric study based on the effects of wall superheat, contact angle and wick porosity on evaporation rates was also conducted. In a related study [8], an effective thermal resistance for the conduction/evaporation process, from the bottom of wick structure to the saturated vapor, was proposed for a packed-sphere wicking structure. Zhao et al. [9] investigated the effect of temperature-dependent thermophysical properties on modeling the evaporating liquid meniscus in rectangular microchannels. Cheng et al. [10] developed a mathematical model to determine heat transfer through both the thin-film and bulk regions of a liquid in a rectangular microgroove.

In the current investigation, a detailed mathematical model predicting the effect of the thin film region on the evaporating heat transfer in a rectangular groove has been developed in order to find the maximum evaporating heat transport capacity through the thin film region.

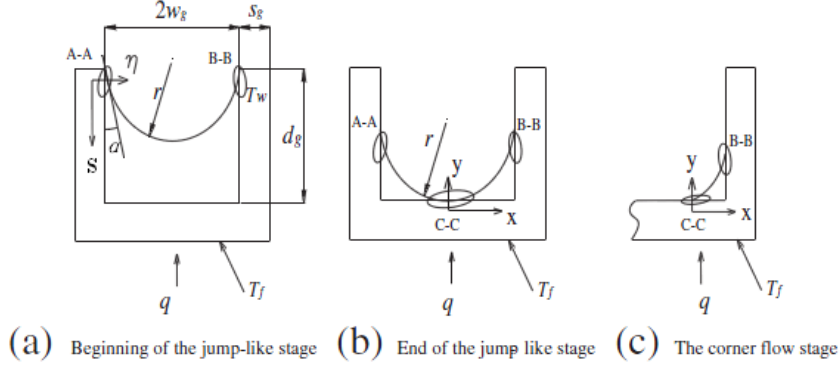
## **2. Film thickness and evaporation heat transfer in thin film region**

As shown in Fig. 1, the axial flow in the rectangular groove can be divided into three stages [11-13], i.e., the accommodation stage, the jump-like stage, and the corner flow stage. When heat is added on the bottom of the rectangular groove, the heat will transfer through the solid regions of groove wall and reach the working fluid. On two-dimensional cross-section of the microgroove, as shown in Fig. 2, when the meniscus comes close to the side wall, the thin liquid film in the vicinity of the triple-phase contact line, which is defined as micro region in the paper, evaporates intensively. Most of the heat will transfer through thin film regions. In the accommodation stage, the liquid film can be formed on the side wall of the micro groove with two extensive evaporating thin film regions. At the jump-like stage, there are two intensive evaporating thin films on the groove side walls: A-A and B-B regions in Fig. 2(a), and due to the groove symmetry, the A-A thin film region is the same as the B-B thin film region; when the meniscus touches the bottom of the groove, there are not only two side thin films: B-B region, but also two bottom thin films: C-C region in Fig. 2(b); at the stage of corner flow, each triangular zone has two intensive evaporating thin films: B-B and C-C regions in Fig. 2(c). Therefore, at different axial flow stage, the liquid film distribution on the cross section is different, and the heat transfer characteristics are also different.

For the thin film evaporation heat transfer, the liquid-vapor interface temperatures on those thin film regions can be depicted by the Clausius-Clapeyron equation [14, 15].



**Fig. 1. Schematic of axial flow along the rectangular microgroove**



**Fig. 2. Liquid configuration on cross-section of the rectangular microgroove**

$$\left( \frac{dp}{dT} \right)_{sat} = \frac{h_{fg}}{T_{sat} [(1/\rho_V) - (1/\rho_L)]} \quad (1)$$

Integrating from the saturated temperature  $T_{sat}$  to the interface temperature  $T_{LV}$  results in a relationship between the interface temperature and the saturated vapor temperature, i.e. ,

$$T_{LV} = T_V [1 + (\Delta p / \rho_V h_{fg})] \quad (2)$$

where can be found from

$$\Delta p = \sigma / r + p_d \quad (3)$$

where the second term,  $p_d$ , in Eq. (3) can be calculated by the equation developed by Holm and Goplen<sup>[16]</sup>:

$$p_d = \rho_L R_V T_{sat} \ln(a\delta^b) \quad (4)$$

In the non-evaporating film region, the curvature effect can be neglected due to the absence of vaporization. The interface temperature at this region will be equal to the wall temperature due to the interface thermal resistance. Substituting Eqs. (3) and (4) into Eq. (2), the film thickness in this region can be obtained as

$$\delta_0 = e \times \left[ \frac{T_w}{T_{sat}} - 1 \right] \left( \frac{\rho_V h_{fg}}{\rho R_V T_{sat}} \right)^{-1/b} \quad (5)$$

Based on the geometry dimensions of the rectangular shape, the film thickness in A-A and B-B regions can be calculated by:

$$\delta_{A-A} = \delta_{B-B} = w_g + \delta_0 - \sqrt{r^2 - (r \sin \alpha + s)^2} \quad (6)$$

$$\delta = \delta_0, \quad r \rightarrow \infty, \quad T_{LV} = T_W; \quad \text{at } s = 0$$

Based on the contact angle and dimensions shown in Fig. 2, the meniscus radius can be written as:

$$r = \frac{w_g}{\cos \alpha} \quad (7)$$

Based on the geometry dimensions of the rectangular shape and the definition of contact angle, the film thickness for both the C-C and D-D regions can be calculated by:

$$\delta_{C-C} = r + \delta_0 - \sqrt{r^2 - x^2} \quad (8)$$

$$\delta = \delta_0, \quad r \rightarrow \infty, \quad T_{LV} = T_W; \quad \text{at } x = 0$$

The heat conduction through the thin liquid film is assumed normal to the wall of the groove. The extremely small thickness of the liquid layer in the evaporating thin film region makes it necessary to consider the interfacial heat resistance. Then the heat flux through the thin liquid film can be written as:

$$q_{micro} = \frac{T_W - T_{LV}}{\frac{\delta}{k_L} + \frac{R_i}{\sqrt{1 + \left(\frac{d\delta}{ds}\right)^2}}} \quad (9)$$

$$R_i = \frac{2-f}{2f} \cdot \frac{T_{sat} \sqrt{2\pi R_V T_{sat}} \Delta V}{h_{fg}^2 \rho_V} \quad (10)$$

So the heat flux through the thin liquid film can be expressed as:

$$q_{micro} = \frac{T_W - T_{LV}}{\frac{\delta}{k_L} + \frac{T_{sat} \sqrt{2\pi R_V T_{sat}} (2-f)}{h_{fg}^2 \rho_V}} \quad (11)$$

At the accommodation stage, the heat transfer through evaporating thin films on two-dimensional cross-section of the microgroove can be calculated by:

$$Q_{micro1} = 2 \int_0^s q_{micro}(s) ds \quad (12)$$

At the jump-like stage or the corner flow stage, there are four evaporating thin films, the heat transfer through four thin films can be calculated by:

$$Q_{micro2} = 2 \int_0^s q_{micro}(s) ds + 2 \int_0^x q_{micro}(x) dx \quad (13)$$

### 3. Heat transfer through macro-region

Because the groove dimension as shown in Fig. 2 is in a range of 0.2–0.4 mm and the Bond number is much less than 1, the temperature distribution in the macro-liquid film region can be described by the two-dimensional, steady-state heat conduction equation,

$$\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2} = 0 \quad (14)$$

The solution for Eq. (14) can be obtained by the FLUENT software, and the heat transfer through the macro-region can be obtained. The grid width near the evaporating thin film is extremely small in order to improve calculation accuracy. In the macro region, the effect of disjoining pressure on the interface temperature can be neglected. The liquid-vapor interface temperature in the macro region can be determined by

$$T_{LV} = T_{sat} [1 + (\sigma / \rho_V h_{fg})] \quad (15)$$

Using Eq. (15) for the liquid–vapor interface temperature, the heat transport  $Q_{macro}$  through the macro-region of liquid for a given superheat can be calculated. The total heat transport from the solid wall to the liquid can be determined by

$$Q_{total} = Q_{macro} + Q_{micro} \quad (16)$$

Where,  $Q_{micro}$  can be calculated by Eq. (13) for a given superheat. During the iterative calculation, when the error is less than 0.1 W, the calculation is considered as the converged results.

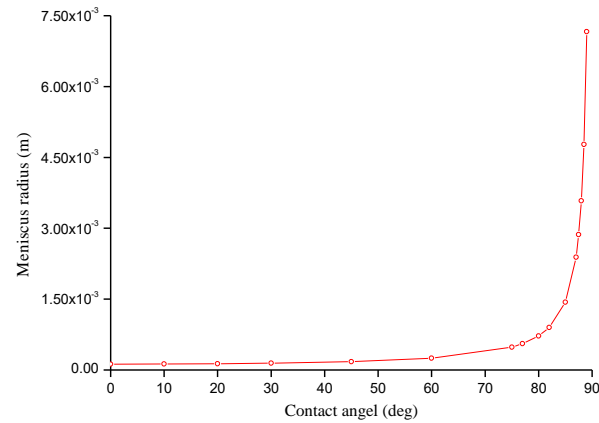
### 4. Results and discussions

The disjoining pressure and interface curvature significantly influence the variation of film thickness, interface temperature, and heat flux distribution. In order to better illustrate effects on the meniscus radius, heat flux distribution and heat transport capacity, a rectangular groove, similar to the one shown in Fig. 2, with dimensions of  $w_g = 0.000125$  m,  $d_g = 0.0005$  m,  $s_g = 0.0004$  m, and a groove number of 30, is considered. The thermophysical properties of borosilicate glass and pure saturated water at 60 °C are utilized in the current investigation.

Fig. 3 shows the influence of contact angle on the meniscus radius. As shown, it can be seen that the meniscus radius increases nonlinearly with the improvement of contact angle. For example, when the contact angle changes from  $\alpha = 0^\circ$  to  $\alpha = 45^\circ$ , the radius changes slowly and the ratio of the meniscus radius at  $\alpha = 45^\circ$  to the one at  $\alpha = 0^\circ$  is equal to 1.414, the ratio of the meniscus radius at  $\alpha = 60^\circ$  to the one at  $\alpha = 45^\circ$  is also equal to 1.414, while the ratio of the meniscus radius at  $\alpha = 89^\circ$  to the one at  $\alpha = 60^\circ$  is 29.4. It shows that when the contact angle is less than  $60^\circ$ , the further decrease of the contact angle is not significantly further reduce the meniscus radius. When the contact angle is  $90^\circ$ , the meniscus radius tends to infinity.

Fig. 4 and Fig. 5 show the influence of contact angle on thin film thickness in A–A (or B–B) and C–C regions for rectangle microgroove respectively. As shown, the thin film

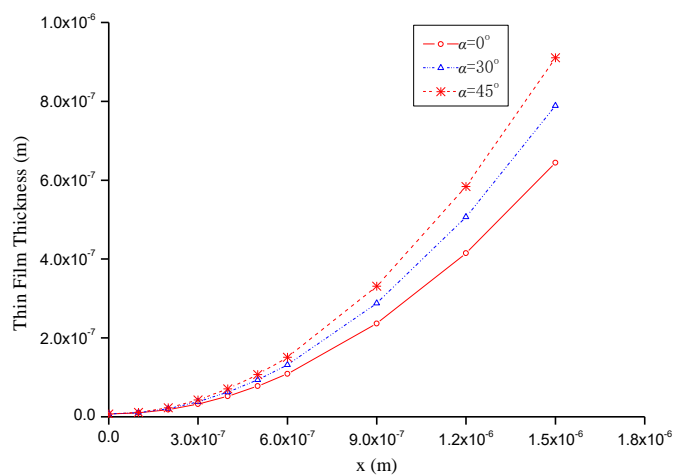
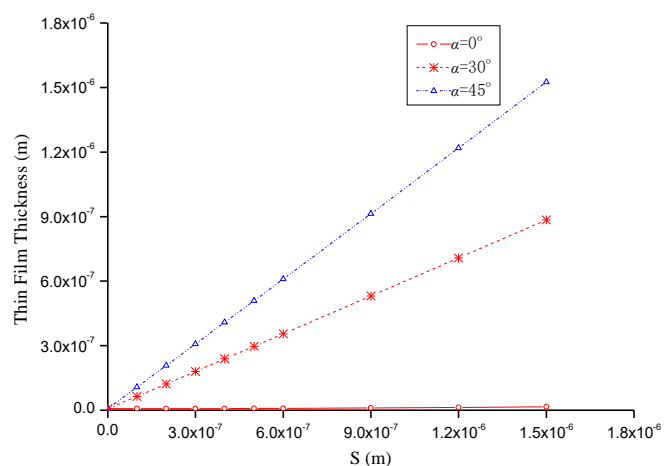
thickness in the A–A (or B–B) thin film region largely depends on the contact angle, while the thin film thickness in the C–C thin film region changes with the improvement of the contact angle insignificantly. The thin film thickness in the A–A (or B–B) region almost increases linearly as the contact angle increases, while the thin film thickness in the C–C region increases nonlinearly with the improvement of contact angle. When the contact angle further increases, the thin film thickness in the A–A (or B–B) region for rectangle microgroove increases very sharply. The difference is that the thin film thickness in A–A (or



B–B) region increases slowly along the s-direction when the contact angle is equal to zero.

**Fig. 3. Meniscus radius versus contact angle**

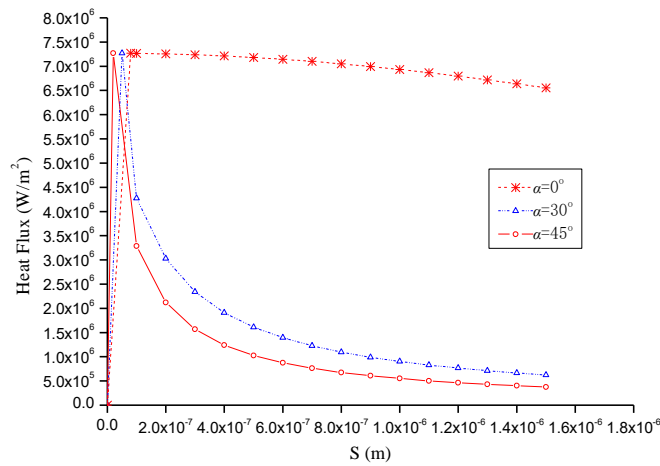
Fig. 4 and Fig. 5 show the influence of contact angle on thin film thickness in A–A (or B–B) and C–C regions for rectangle microgroove respectively. As shown, the thin film thickness in the A–A (or B–B) thin film region largely depends on the contact angle, while the thin film thickness in the C–C thin film region changes with the improvement of the contact angle insignificantly. The thin film thickness in the A–A (or B–B) region almost increases linearly as the contact angle increases, while the thin film thickness in the C–C region increases nonlinearly with the improvement of contact angle. When the contact angle further increases, the thin film thickness in the A–A (or B–B) region for rectangle microgroove increases very sharply. The difference is that the thin film thickness in A–A (or B–B) region increases slowly along the s-direction when the contact angle is equal to zero.



**Fig. 4. Meniscus radius versus contact angle in A–A (or B–B) thin film region**

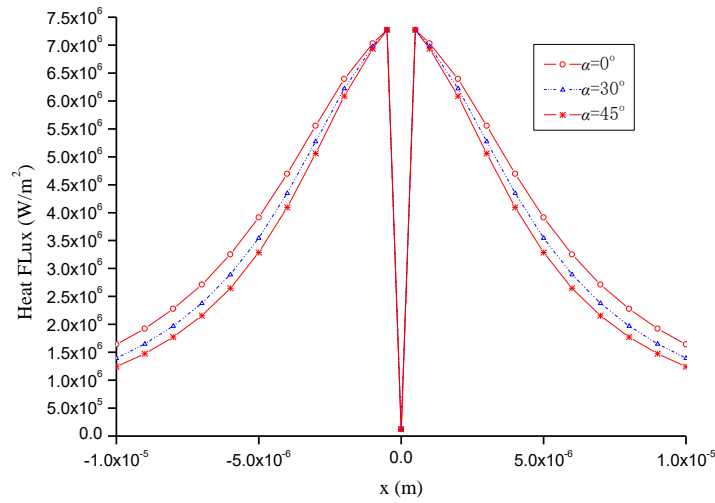
**Fig. 5. Meniscus radius versus contact angle in C–C thin film region**

Fig. 6 and Fig. 7 show the influence of contact angle on heat flux distribution in A–A (or B–B) and C–C thin film regions for rectangle microgroove respectively. As shown, the heat flux distribution in the A–A (or B–B) thin film region largely depends on the contact angle, while heat flux distribution in the C–C region changes with the improvement of the contact angle insignificantly. The heat flux distribution in both A–A (or B–B) and C–C region increases nonlinearly as the contact angle decreases. Although the highest heat flux is nearly the same, the total heat transfer through the thin film region increases with the reduction of contact angle. Comparisons of the results shown in Fig. 6 with those shown in Fig. 7 indicate that the heat flux distributions in A–A (or B–B) and C–C regions for rectangle microgroove are similar. The initial heat fluxes in both regions are zero at the origin point where the film thickness is equal to  $\delta_0$ , and then increase sharply with the improvement of film thickness. After reaching the maximum, the heat flux through the thin film region almost decreases dramatically along the  $s$  (or  $x$ ) direction. The difference is that the heat flux in A–A (or B–B) region decreases slowly along the  $s$ -direction when the contact angle is equal to zero.



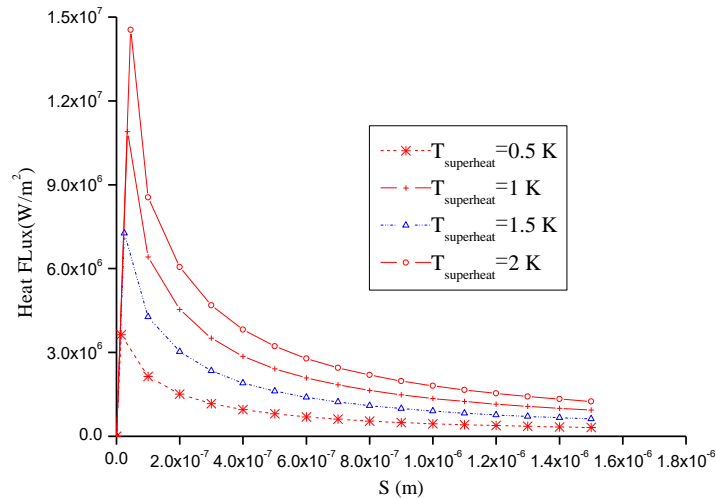
**Fig. 6. Contact angle effect on heat flux distribution in A–A or B–B thin film region at  $T_{\text{superheat}}=1$  K**





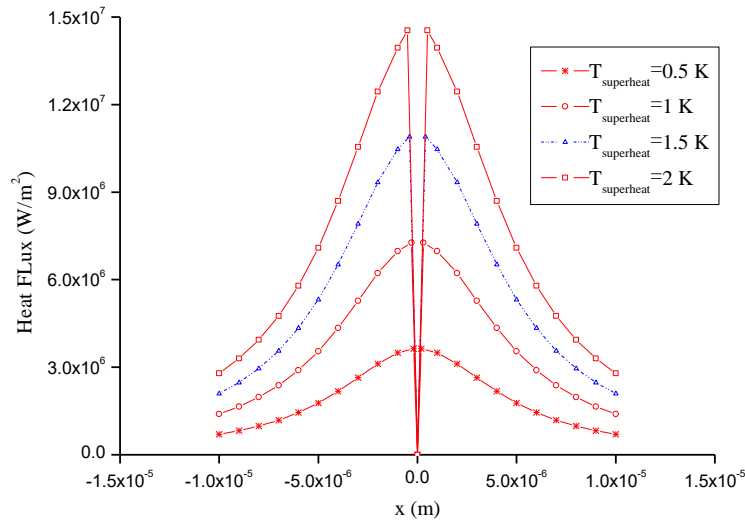
**Fig. 7. Contact angle effect on heat flux distributions in C–C thin film region at  $T_{\text{superheat}}=1$  K**

Fig. 8 and Fig. 9 show the influence of superheat on heat flux distribution in A–A (or B–B) and C–C thin film regions at  $\alpha=30^\circ$  for rectangle microgroove respectively. As shown, the heat flux distributions in the A–A (or B–B) and C–C thin film region largely depend on superheat. With the increase of temperature difference between groove wall and saturate vapor, the heat flux increases and the heat transfer through A–A, B–B or C–C



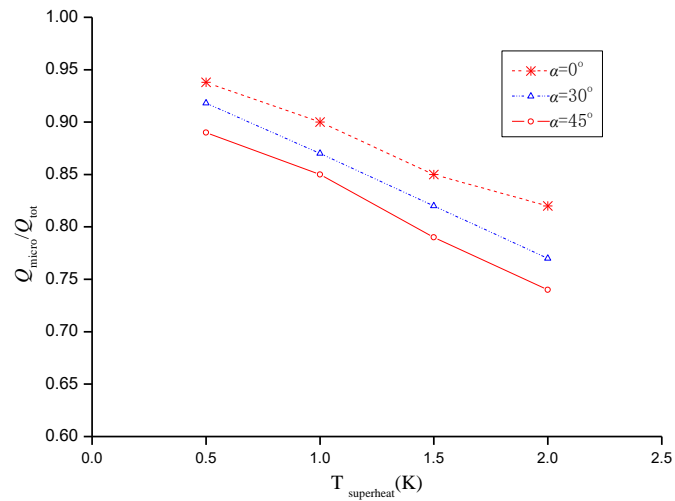
**Fig. 8. Superheat effect on the heat flux distribution in A–A or B–B thin film region at  $\alpha=30^\circ$**

region enhances. The heat flux distributions in both A–A (or B–B) and C–C increase nonlinearly as the contact angle decreases. Comparisons of the results shown in Fig. 8 with those shown in Fig. 9 indicate that the heat flux distributions in A–A (or B–B) and C–C regions for rectangle microgroove are similar too. When the heat flux reaches the maximum, the heat flux through the thin film region decreases dramatically along the s (or x) direction. The total heat transfer through the thin film region increases with the improvement of superheat.



**Fig. 9. Superheat effect on heat flux distributions in C–C thin film region at  $\alpha=30^\circ$**

Fig. 10 shows the influence of superheat on the ratio of the heat transfer through A–A (or B–B) thin film region,  $Q_{\text{micro}}$ , to the total heat transfer,  $Q_{\text{tot}}$ . As shown, it can be seen that, with the increase of the superheat, the ratio decreases and it also depends on the contact



**Fig. 10. Contact angle effect on  $Q_{\text{micro}}/Q_{\text{tot}}$**

angle. The main reason is that the thin film region in A–A (or B–B) region has been extended and heat transfer through those regions enhances with the reduction of contact angle. When the contact angle is equal to zero, the heat transfer in the thin film region accounts for more than 80% of the total heat transfer. The reason for high strength heat transfer in the thin film region is the intensive evaporation in the rectangle capillary microgroove. With the increase of contact angle, the proportion of heat transfer in thin film region decreases rapidly. Therefore, the liquid with high wetting performance is more capable of playing the advantages of higher intensity heat transfer in thin film region.

## 5. Conclusions

Physical and mathematical models predicting the effects of contact angle and superheat on the thin film profile for a rectangle microgroove have been developed. The main conclusions are as follows.

- (1) The meniscus radius increases nonlinearly with the improvement of contact angle. When the contact angle in a rectangle microgroove is less than  $60^\circ$ , the further decrease of the contact angle is not significantly further reduce the meniscus radius. When the contact angle is  $90^\circ$ , the meniscus radius tends to infinity.
- (2) The thin film thickness in the A–A (or B–B) thin film region largely depends on the contact angle, while the thin film thickness in the C–C thin film region changes with the improvement of the contact angle insignificantly. The thin film thickness in the A–A (or B–B) region almost increases linearly as the contact angle increases, while the thin film thickness in the C–C region increases nonlinearly with the improvement of contact angle. When the contact angle further increases, the thin film thickness in the A–A (or B–B) region for rectangle microgroove increases very sharply. The difference is that the thin film thickness in A–A (or B–B) region increases slowly along the s-direction when the contact angle is equal to zero.
- (3) The heat flux distribution in the A–A (or B–B) thin film region largely depends on the contact angle, while heat flux distribution in the C–C region changes with the improvement of the contact angle insignificantly. The heat flux distribution in both A–A (or B–B) and C–C region increases nonlinearly as the contact angle decreases. The difference is that the heat flux in A–A (or B–B) region decreases slowly along the s-direction when the contact angle is equal to zero.
- (4) The heat flux distributions in the A–A (or B–B) and C–C thin film region largely depend on superheat. With the increase of temperature difference between groove wall and saturate vapor, the heat flux increases and the heat transfer through A–A, B–B or C–C region enhances.
- (5) The total heat transfer through the thin film region increases with the improvement of superheat, and decreases as the contact angle increases. When the contact angle is equal to zero, the heat transfer in the thin film region accounts for more than 80% of the total heat transfer. Intensive evaporation in the thin film region plays a key role in heat transfer for the rectangle capillary microgroove. The liquid with high wetting performance is more capable of playing the advantages of higher intensity heat transfer in thin film region.

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## Nomenclature

- $a$  constant in Eq. (4),  $a = 1.5787$   
 $b$  constant in Eq. (4),  $b = 0.0243$

$d_g$	depth of microgroove, m
$f$	evaporation coefficient
$h_{fg}$	latent heat, J/kg
$k$	conductivity, W/(m.K)
$p$	pressure, Pa
$Q$	heat transfer, W
$q$	heat flux, W/m <sup>2</sup>
$R_i$	interfacial heat resistance, m <sup>2</sup> . K/W
$R_v$	specific gas constant, J/(kg. K)
$r$	curvature radius of the meniscus, m
$s_g$	spacing of microgroove, m
$T$	temperature, K
$w_g$	half width of microgroove, m

### Greek symbols

$\alpha$	contact angle between the liquid and the groove wall
$\delta$	thickness of the liquid film, m
$\delta_0$	initial thickness of the evaporating thin film, m
$\rho$	density, kg/m <sup>3</sup>
$\sigma$	coefficient of surface tension, N/m

### Subscripts

A–A	A–A thin film region in Fig. 2
B–B	B–B thin film region in Fig. 2
C–C	C–C thin film region in Fig. 2
$d$	disjoining
$L$	liquid
$LV$	liquid-vapor interface
$macro$	macro region
$micro$	micro region
$sat$	saturated
$tot$	total
$V$	vapor
$W$	wall

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